



DB2141200L

Silicon epitaxial planar type

For rectification

■ Features

- Low forward voltage and small reverse leakage current
- Forward current (Average) IF(AV) = 1.5 A rectification is possible
- Halogen-free / RoHS compliant
 (EU RoHS / UL-94 V-0 / MSL:Level 1 compliant)

■ Marking Symbol: 4S

■ Packaging

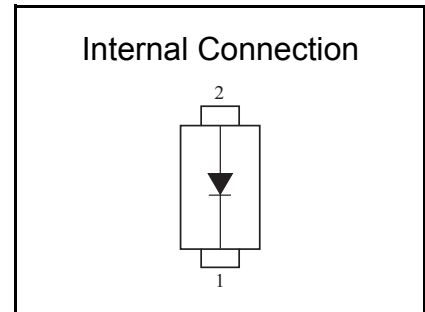
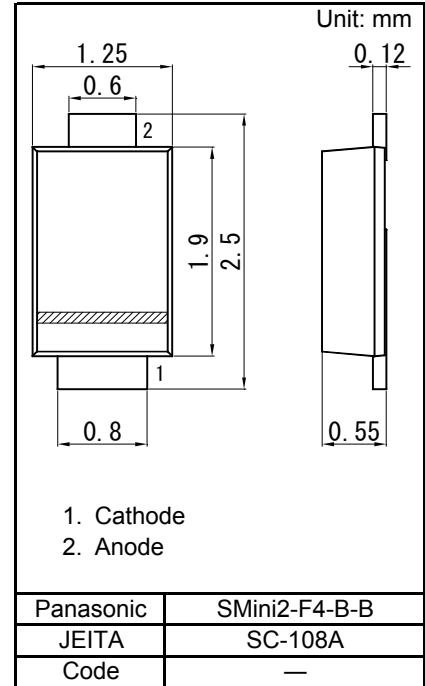
Embossed type (Thermo-compression sealing) : 3 000 pcs / reel (standard)

■ Absolute Maximum Ratings Ta = 25 °C

| Parameter | Symbol | Rating | Unit |
|--|--------|-------------|------|
| Reverse voltage | VR | 40 | V |
| Forward current (average) *1 | IF(AV) | 1.5 | A |
| Non-repetitive peak forward surge current *2 | IFSM | 30 | A |
| Junction temperature *1 | Tj | 150 | °C |
| Operating ambient temperature | Topr | -40 to +85 | °C |
| Storage temperature | Tstg | -55 to +150 | °C |

Note: *1 TI = 80 °C

*2 50 Hz sine wave 1 cycle (Non-repetitive peak current)



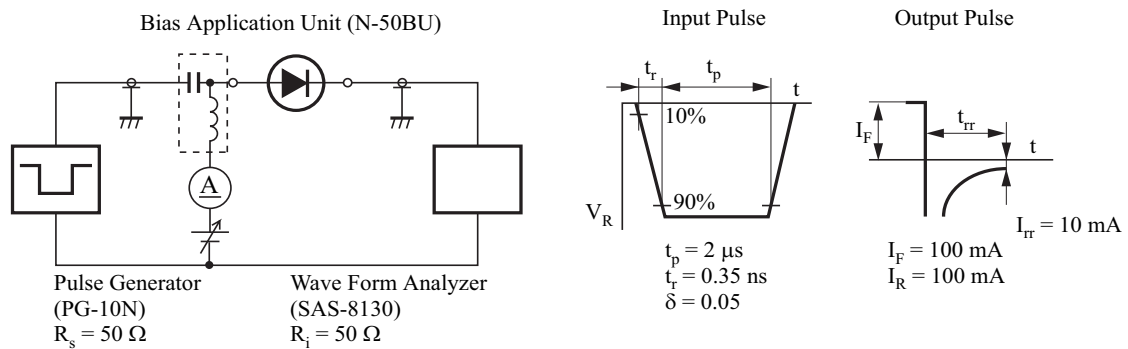


■ Electrical Characteristics $T_a = 25\text{ }^\circ\text{C} \pm 3\text{ }^\circ\text{C}$

| Parameter | Symbol | Conditions | Min | Typ | Max | Unit |
|--------------------------|--------|-------------------------------|-----|------|------|---------------|
| Forward voltage | VF | IF = 1.5 A | | 0.41 | 0.48 | V |
| Reverse current | IR | VR = 40 V | | 25 | 150 | μA |
| Terminal capacitance | Ct | VR = 10 V, f = 1 MHz | | 43 | | pF |
| Reverse recovery time *1 | trr | IF = IR = 100 mA, Irr = 10 mA | | 12 | | ns |

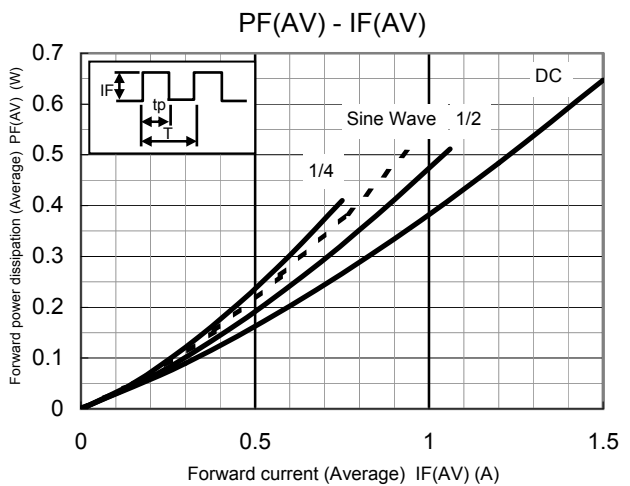
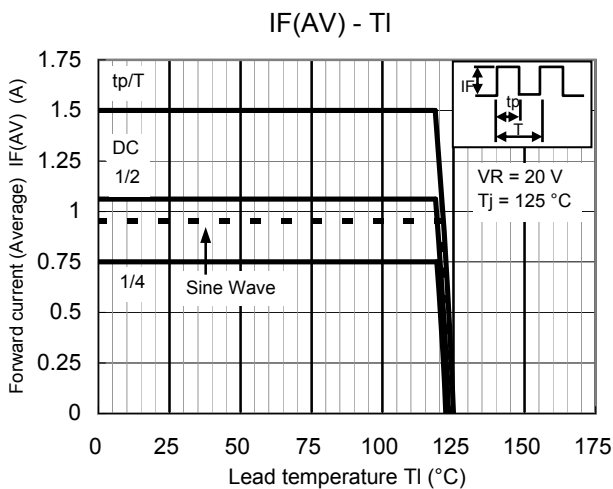
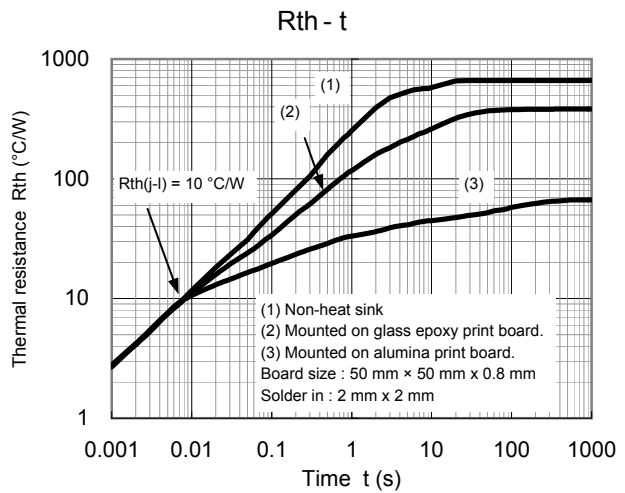
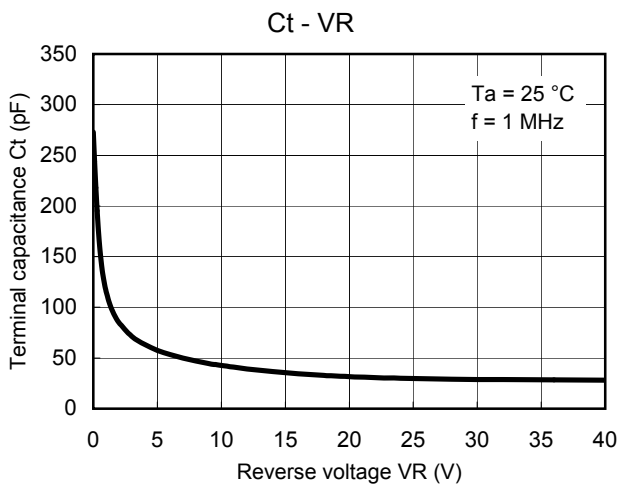
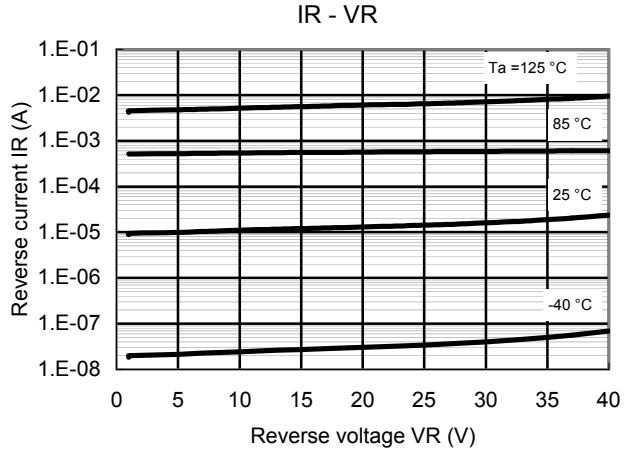
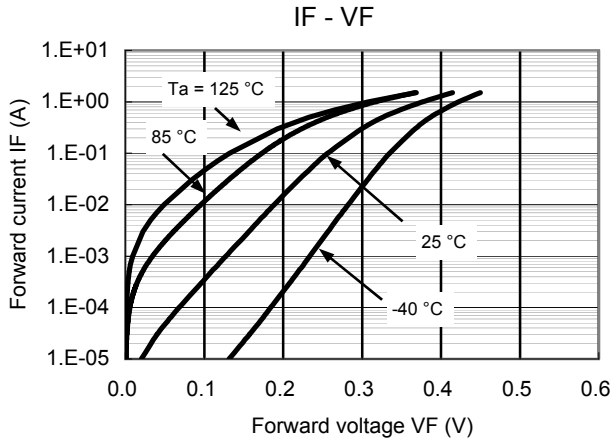
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 Measuring methods for Diodes.

- This product is sensitive to electric shock (static electricity, etc.). Due attention must be paid on the charge of a human body and the leakage of current from the operating equipment.
- *1 trr test circuit





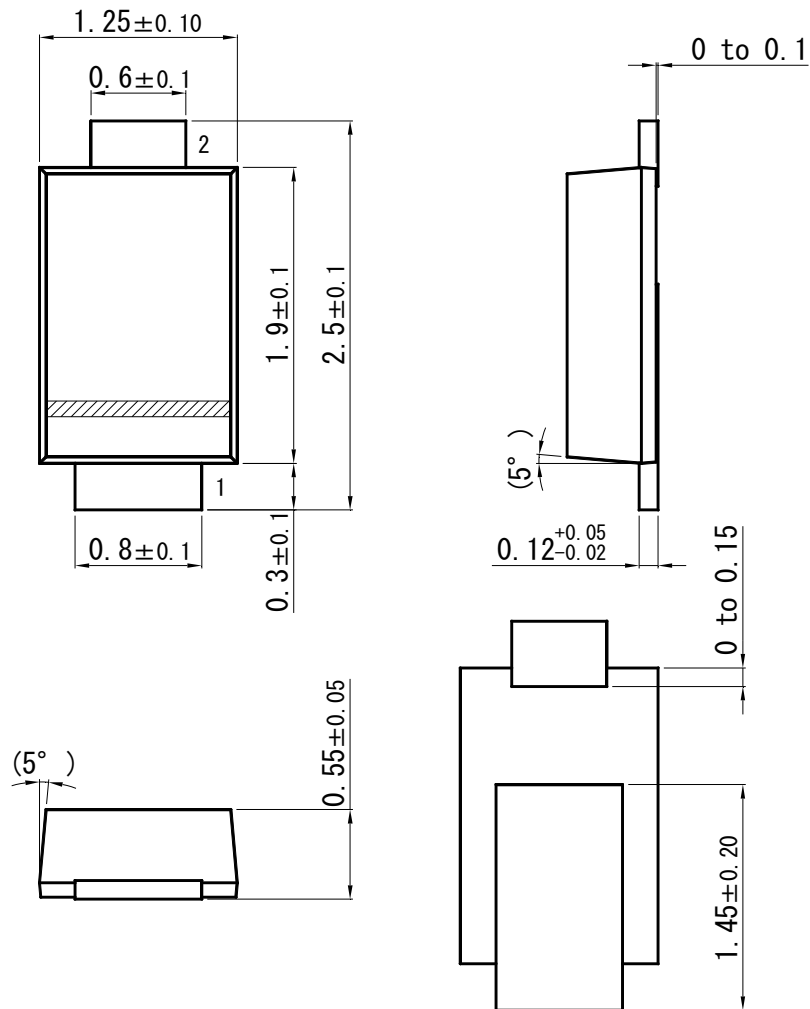
Technical Data (reference)



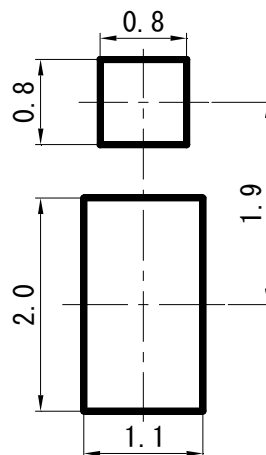


SMini2-F4-B-B

Unit: mm



■ Land Pattern (Reference) (Unit: mm)



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